

SPECIFICATION FOR APPROVAL

Customer Part No. :

Brightek Part No. : V52720V27CNN1

Time : 2022/05/20

Customer Confirmation	Approval	Checked By	Prepared By
	Wilson	CB.Tan	GP.Liu



V52720V27CNN1

- **♦**Outline(L*W*H): 2.75*2.0*0.6 mm
- **♦**High flux efficiency & Energy conservation
- **♦**Good thermal dissipation & optical uniformity



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Features

- Forward current: \(\leq 240mA \)
- Typical view angle 50% Iv: 120°
- RoHS2.0 and REACH-compliant
- Lens color: water transparent
- Qualified according to JEDEC moisture sensitivity
 Level 2a
- ESD level 2kV(HBM)
- Reliability Test: AEC Q-102qualified

Applications

- Automotive electronics
- Others applications



■ Product Code Method

V5 - 2720 - V27 - C - N - N1

1

2

3

5

(C)	
(0)	

1)	2	3	4	(5)	6
Process Type	Lead Frame Size	Dice wavelength	Cap Color	Spectral Condition Code	Flow Code
V5 : For Automotive	2720: 2.75* 2.0mm	Vxx: red	C: water transparent	N:200mA	N1: no expression above meaning for company

■ Maximum Rating(Ta=25°C)

Characteristics	Symbol	Typical	Unit	
DC Forward Current	I_{F}	240	mA	
Pulse Forward Current*3	$ m I_{PF}$	500	mA	
Reverse Voltage	V_R	5	V	
Junction Temperature	T_{J}	150	°C	
Operating Temperature Range	T_{OPR}	-40-125	°C	
Storage Temperature Range	T_{STG}	-40-125	°C	
Soldering Temperature*4	T_{SD}	260	°C	
Thermal Resistance Junction/ Solder Point	RTH _{J-S}	20	°C/W	

Notes 1: There is no maximum or typical voltage parameter

2: For other ambient, limited setting of current will be depended on de-rating curves.

3: Duty 1/10, pulse width 10ms

4: The maximum of soldering time is 10 seconds in T_{SD}



■ Typical Product Characteristics(Ta=25°C)

Characteristics	Symbol	Min.	Тур.	Max.	Unit	Test condition
Forward Voltage	V_{F}	1.8	2.3	2.8	V	I _F =200mA
Luminous Intensity ²	Φ	18	22	-	lm	I _F =200mA
Dominant Wavelength	λd	628	632	-	-	I _F =200mA
Reverse Current	I_R	-	-	10	μΑ	$V_R = 5V$
Viewing Angle	$2\theta_{1/2}$	-	120	-	deg	I _F =200mA

Notes: 1. Measurement errors:

Forward Voltage: ± 0.1 V, Luminous Intensity: $\pm 10\%$ Iv, Color Coordinate: ± 0.005 , Viewing Angle $(2\theta_{1/2}) \pm 5\%$

2. Electrical-Optical Characteristics (Ta=25°C)

■ Range of Bins

1). Forward Voltage ($I_F = 200 \text{mA}$)

Bin Code	Min. V _F (V)	Max. V _F (V)
E	1.8	2. 0
F	2. 0	2. 2
G	2. 2	2. 4
Н	2. 4	2. 6
Ј	2. 6	2.8

2). Luminous Intensity ($I_F = 200 \text{mA}$)

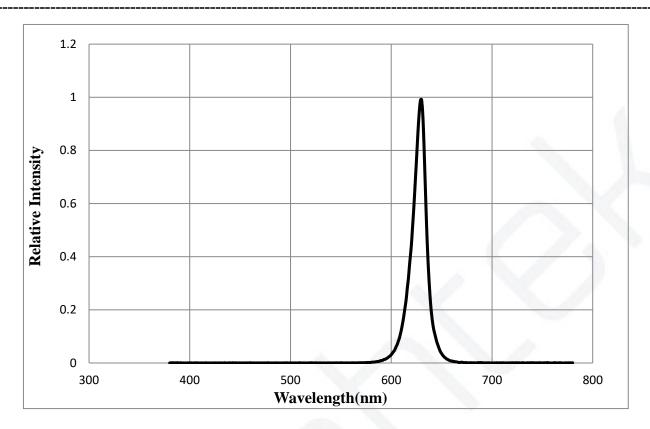
Bin Code	e Min. Φ(lm) Max. Φ(lm)	
14	18	21
15	21	24
16	24	28

3) Dominant Wavelength (I_F =200mA)

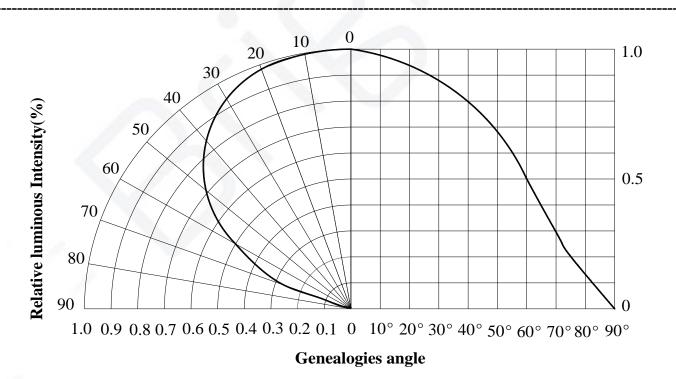
Bin Code	Min.λd (nm)	Max.λd(nm)
V3	628	633
V4	633	638



■ Relative Spectral Power Distribution



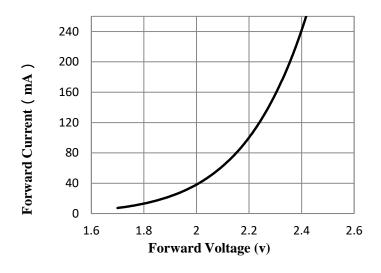
■ Typical Diagram Characteristics of Radiation



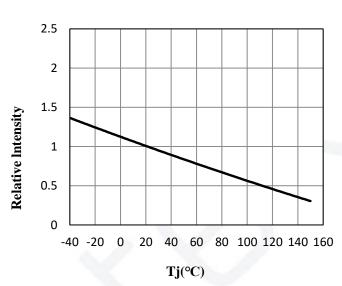


■ Relative Spectral Power Distribution

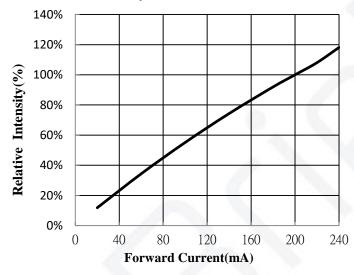
Forward Current vs. Forward Voltage temperature



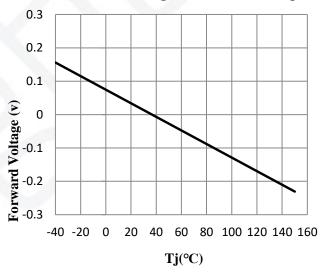
Relative Intensity vs. Junction



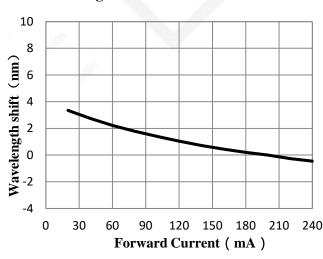
Relative Intensity vs. Forward Current



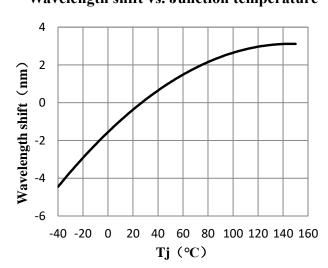
Forward Voltage vs. Junction temperature



Wavelength shift vs. Forward Current



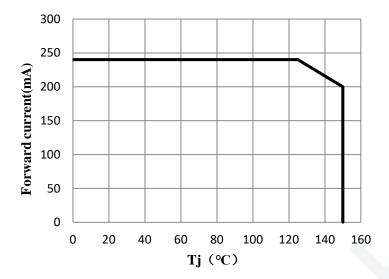
Wavelength shift vs. Junction temperature





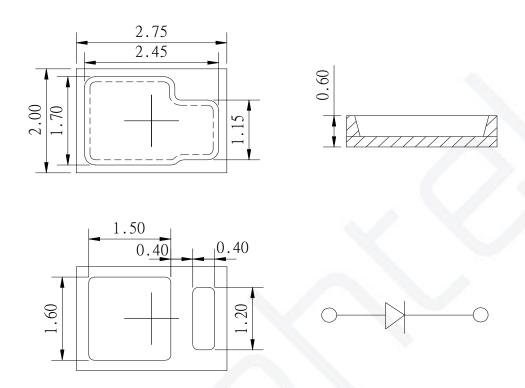
■ Thermal Design for De-rating

The maximum forward current is determined by the thermal resistance between the LED junction and solder point. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.

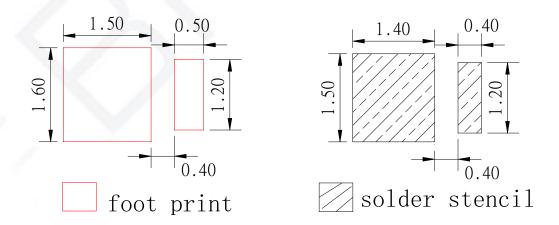




Dimensions



Recommended Solder Pad



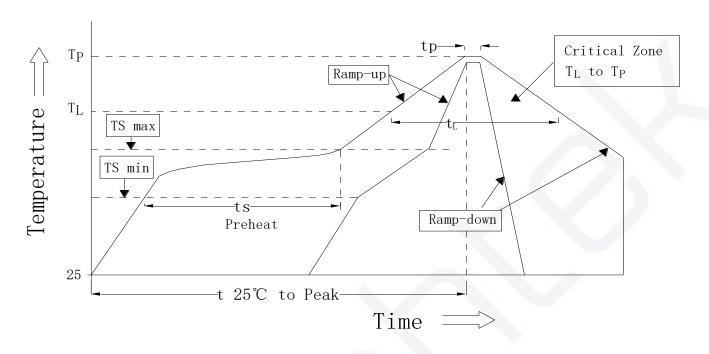
Notes: 1. All dimensions are in millimeters

- 2. Tolerance is ± 0.1 mm unless otherwise noted
- 3. Specifications are subject to change without notice.



■ Reflow Profile

SMT Reflow Soldering Profile



D. Cl. E. A	Symbol	Pb-F	T I •4		
Profile Feature		Min.	Recommendation	Max.	Unit
Ramp-up rate to preheat (25°C to 150°C)	1	-	2	3	K/s
Time t_S $(T_{S \text{ min}} \text{ to } T_{S \text{ max}})$	t_{S}	60	100	120	S
Ramp-up rate to peak (T _{S max} to T _P)	-	-	2	3	K/s
Liquidus temperature	T_{L}	-	217	-	°C
Time above liquidus temperature	$t_{ m L}$	-	80	100	S
Peak temperature	T _P	-	245	260	°C
Time within 5 °C of the specified peak temperature T _P - 5 K	t _P	-	-	10	S
Ramp-down Rate (T _P to 100 °C)	-	-	3	4	K/s
Time 25 °C to T _P	-	-	-	480	S

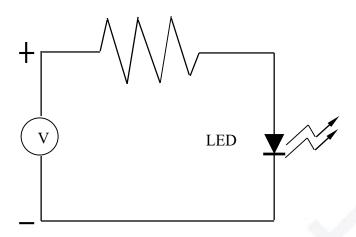
Notes:

- 1. Do not stress the silicone resin while it is exposed to high temperature.
- 2. The reflow process should not exceed 3 times.



■ Test Circuit and Handling Precautions

1. Test Circuit



2. Handling Precautions

2.1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2.2. Storage

1). It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature: $5^{\circ}\text{C} \sim 30^{\circ}\text{C} (41^{\circ}\text{F} \sim 86^{\circ}\text{F})$

2). Shelf life in sealed bag: 12 month at $<5^{\circ}\text{C} \sim 30^{\circ}\text{C}$ and <60% R.H. after the package is Opened, the products should be used within four weeks or they should be keeping to stored at $\leq 20\%$ R.H. with zip-lock sealed.

2.3. Baking

If the package has been opened for more than 4 weeks, it is recommended to bake the products with the following instruction:

1). $60\pm3^{\circ}$ C X 6hrs and <5%RH, for reel

2). 125±3°C X 2hrs, for single LED

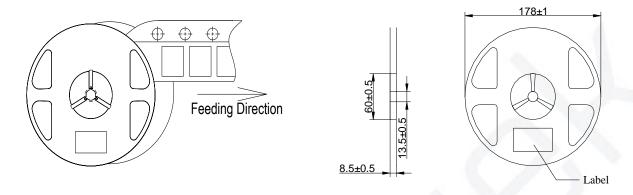
It shall be normal to see slight color fading of carrier (light yellow) after baking in process



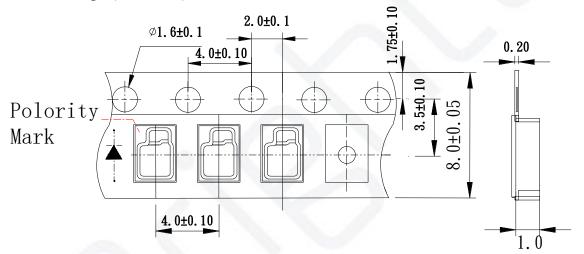
■ Packing

• Feeding Direction (Unit: mm)

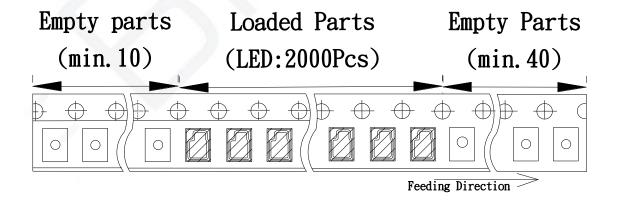
Dimensions of Reel (Unit: mm)



Dimensions of Tape (Unit: mm)



Arrangement of Tape



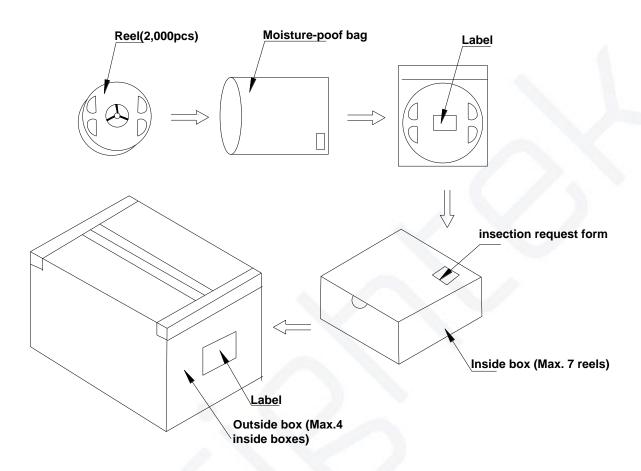
Notes:

- 1. Empty component pockets are sealed with top cover tape
- 2. The max loss number of SMD is 2pcs;
- 3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications;
- 4. 2,000pcs per reel;
- 5. The remainder packing in multiples of 500pcs.



Packing

• Packaging Specifications



Notes:

Reeled product (max.2,000) is packed in a sealed moisture-proof bag. Seven bags are packed in an inner box (size: about 260 X 230 X 100 mm) and four inner boxes are in an outer box (size: about 480 X 275 X 215 mm). On the label of moisture-poof bag, there should be the information of Part No., Lot No. and quantity number; also the total quantity number should be on inspection request form on outer box.

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Precautions

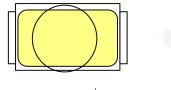
1. Abnormal situation caused by improper setting of collet

To choose the right collet is the key issue in improving the product's quality. LED is different from other electronic components, which is not only about electrical output but also for optical output. This characteristic made LED more fragile in the process of SMT. If the collet's lowering down height is not well set, it will bring damage to the gold wire at the time of collet's picking up and loading which will cause the LED fail to light up, light up now and then or other quality problems

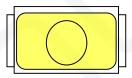
2. How to choose the collet

During SMT, please choose the collet that has larger outer diameter than the lighting area of lens, in case that improper position of collet will damage the gold wire inside the LED. Different collets fit for different products, please refer to the following pictures cross out

Outer diameter of collet should be larger than the lighting area







Picture 2(X)

3. Other points for attention

- A. No pressure should be exerted to the epoxy shell of the SMD under high temperature.
- B. Do not scratch or wipe the lens since the lens and gold wire inside are rather fragile and cross out easy to break.
- C. LED should be used as soon as possible when being taken out of the original package, and should be stored in anti-moisture and anti-ESD package.

4. This usage and handling instruction is only for your reference.

Note: Version updates will not be announced and Brightek will have the final interpretation rights